JST	J.S.T. Mfg. Co., Ltd.	Pag	ge 1/7
	HANDLING MANUAL	Issue No.	Rev.
Title of Document:	HANDLING MANUAL	CHM-1-2434	1
Customer:	GENERAL	Issue date:	
Customer.	GENERAL	April 25, 2012	
Title subject:	FHA Connector (Gold-Plated, Halogen-Free)	Revision date:	
The subject.	FIA Connector (Gold-Flated, Halogen-Flee)	May 2, 2024	

This manual describes important and required points of handling about the FHA connector (gold-plated, halogen-free) Be sure to read this manual thoroughly before using the FHA connector.

<u>C O N T E N T S</u>

	Page
Model Number and Part Name	2
Storage	2
2-1 Storing the connector2-2 Storing the processed products	2 2
Applicable FPC	3
PC Board Pattern Layout	4
Handling Precautions	5
5-2 Handling of FPC after mounting on PC board 5-3 Precautions for soldering operation	6 7
	Model Number and Part Name. 1-1 Model number 1-2 Part name Storage 2-1 Storing the connector 2-2 Storing the processed products Applicable FPC PC Board Pattern Layout Handling Precautions 5-1 Inserting and extracting FPC. 5-2 Handling of FPC after mounting on PC board 5-3 Precautions for soldering operation 5-4 Others

K,Notsu T.Yamashita Y.Kyogoku M.Araki	Prepared by:	Checked by:	Reviewed by:	Approved by:
	K,Notsu	T.Yamashita	Y.Kyogoku	M.Araki

20240517J397456

This document or attachment contain information that is proprietary to J.S.T. and shall not be used or shown without written permission.

		(2/7)
JST Title subject: FHA Connector (Gold-Plated, Halogen-Free)	No.	CHM-1-2434
1. Structure and Name		
1-1 Each part name		
Each part name of the connector is shown below.		
Contact		
	ontact A	
		<u> </u>
X-X' cross section		
	ontact B	
U Y-Y' cross section		
Housing Reinforcing tab		
Fig.1: Each part name (connector)		

1-2 Model number

Part name	Model number
FHA connector (Taping)	* FHA-SM1-GAN-ETB(HF)
FHA connector (loose piece)	* FHA-SM1-GAN(HF)

Note₁: Figures in an asterisk denote the circuit number.

2. Storage

2-1 Storing the connectors

Recommended storage condition: Temperature: 5 - 35 °C, Relative humidity 60 % or less (Under packaging like the state of JST shipment)

Keep off direct sunlight, places exposing to such corrosive gas as industrial gas (generate from a stove and whatnot) and ammonia gas (generate from a toilet and whatnot) and dusty place.

Note that the resin molding part may break due to transportation and handling, such as processing and mating, under dry or low temperature condition.

Recommended storage period: Within 6 months after the delivery

2-2 Storing the processed products

Not leaving the crimped contact to stand in a place exposed to high humidity and direct sunshine, and not placing them directly on the ground. Keep them in a clean storage room.

_					(3/7)
JST	Title subject:	FHA Connector (Gold-Plated, Halogen-Free)	C	No.	CHM-1-2434

3. Applicable FPC

- ① The dimensions of FPC greatly affect the contacting reliability with the connector. Conform the dimensions of FPC with those of applicable ones described in the drawing attached to the specification.
- ② Especially, narrow pitch connectors have a high possibility to come off of the contact point due to warpage,

deformation, slant insertion, insufficient insertion and so on of FPC.

In order to reduce these risks, manage that the important dimensions such as conductor width, length, pitch, FPC total width, position misalignment between conductor and FPC width shall meet the given tolerances, considering the variations of those dimensions.

- ③ Confirm the applicability of the connector with the FPC used, before using. FPC, which applicability is not confirmed, might not be able to guarantee the performance.
- The blanking shall be conducted from the conductor side to the reinforcing plate side. When using FPC, the material of the reinforcing plate should be polyimide and that of the adhesive should be thermosetting.
- ⑤ Do not use FPCs with a different kind of metal plating from the connector to be mated.

Item		Rated value
	Lead:	Gold-plated copper foil
Applicable FPC	Lead pitch:	0.5 mm
(KRD-31874-4)	Lead width:	0.35 mm
	Mating part thickness:	$0.3\pm0.05~\text{mm}$

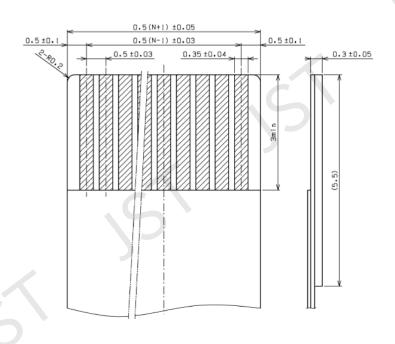
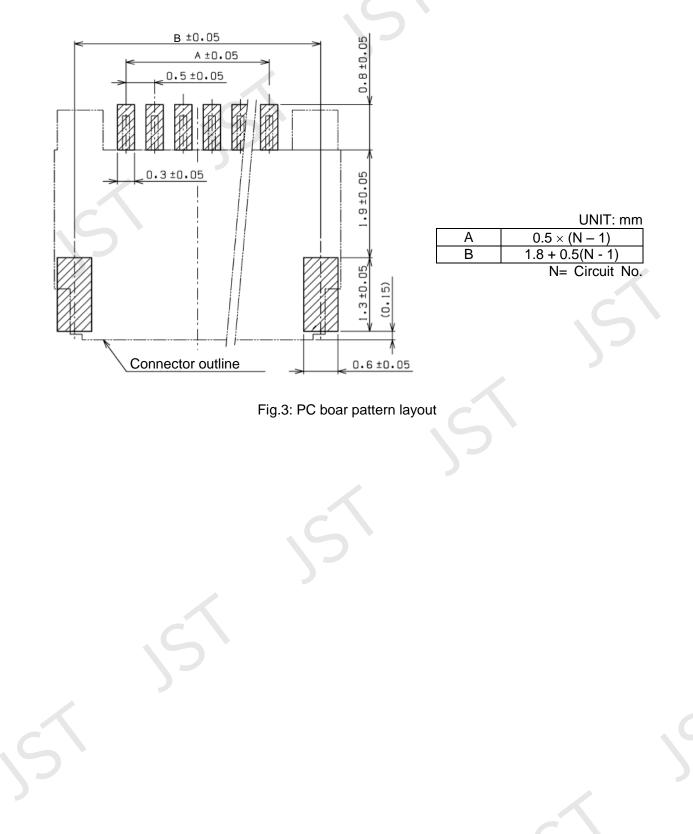


Fig.2: Applicable FPC

				(4/7)
JST	Title subject:	FHA Connector (Gold-Plated, Halogen-Free)	No.	CHM-1-2434

4. PC Board Pattern Layout

We recommend the use of the following PC board pattern layout (viewed from the connector mounting side).



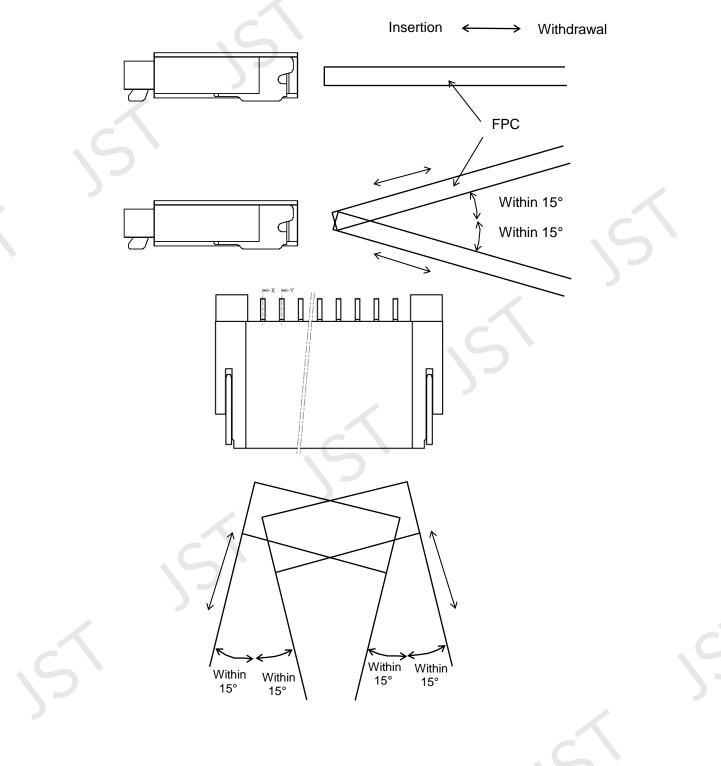
No. CHM-1-2434

(5/7)

- Handling Precautions 5.
 - 5-1 Inserting and withdrawing FPC

Do the inserting and extracting operations of a FPC with FHA connector on the same axis to avoid applying a load to the connector. When the operation on the same axis is difficult, conduct the operation quickly within 15-degree range in each direction as described below.

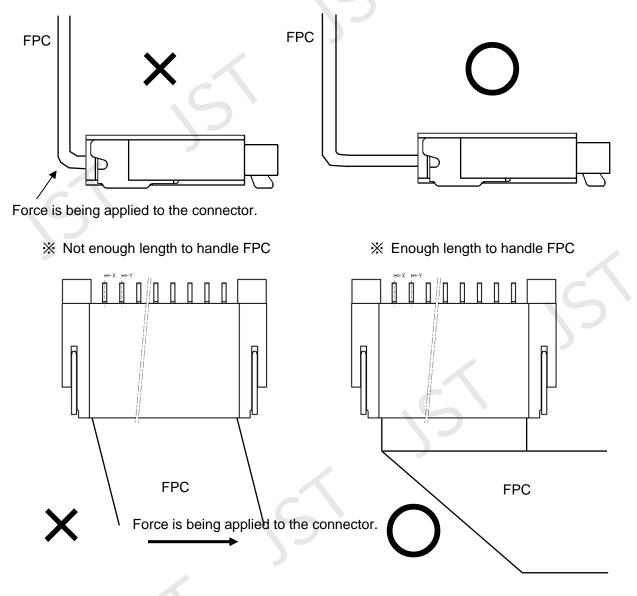
(Because failure to do so may result in connector breakage or electrical discontinuity.)



				(0,1
JST Title	subject:	FHA Connector (Gold-Plated, Halogen-Free)	No.	CHM-1-2434

5-2 Handling of FPC after mounting on PC board

When handling the FPC inserted, ensure that it has sufficient length to avoid applying a load to the FHA connector. (Because failure to do so may result in connector breakage or electrical discontinuity)



* Force is being applied to the connector.

※ Forming processing to FPC not to apply a load to the connector.

When using the connector in areas where the FPC inserted in the connector moves due to the rotating axis of devices or along with the operation of the moveable part, consider taking a countermeasure such as fixing the FPC near the joint part, as poor contact may occur due to fretting corrosion.

No. CHM-1-2434

(7/7

- 5-3 Precautions for Soldering Operation
 - 5-3-1 Solder iron method

Sİ.

Solder the connector mounted on a PC board by a soldering iron of 350°C quickly (within 3 sec.) and check the appearance visually.

When soldering, do not push the iron tip on the connector contact lead part nor apply an abnormal force such as lateral load. If done, dismount and replace the connector with the new one, and redo soldering.

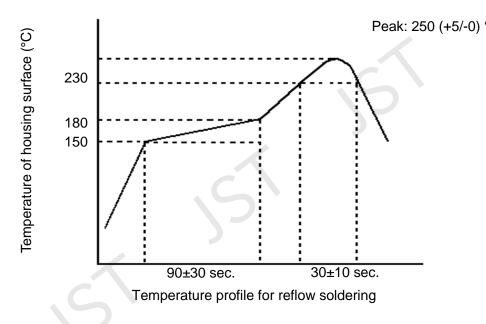
Do not reuse the dismounted connector.

5-3-2 Reflow soldering method

We recommend reflow soldering at a lower temperature than the temperature profile shown below. As the recommended reflow temperature condition varies depending on the materials, such as solder paste, solder the connector according to the condition of the material.

We recommend using some 100 – 120 μ m-thick metal mask which the blanking part has the area same as PC board pad area. In case that the metal mask thickness is more than 120 μ m, adjust the amount (area) of soldering coat by making the opening area smaller than the PC board pad area.

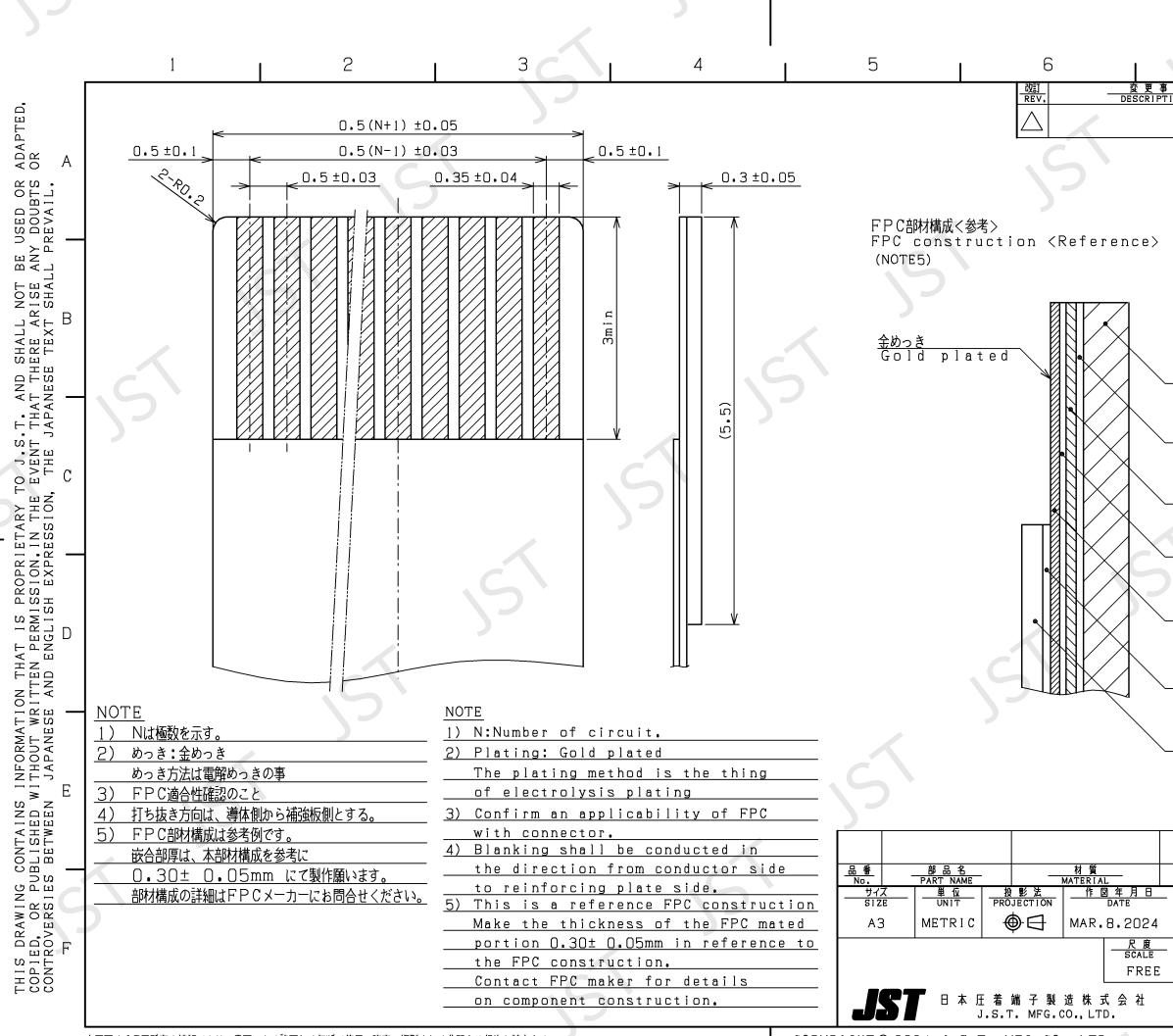
When bridge troubles appear in process of reflow soldering and repair is conducted by hand, strictly conduct item 5-3-1 "Solder iron method."



5-4 Others

- Do not stain the connector with household goods, such as seasoning, detergent, and fruit juice, because such a strain may cause electrical discontinuity, corrosion, and the like. If stained, never use the stained contact.

- Never spray fumy insecticide in the place where the connectors are stored.



本図面はJST所有の情報であり、書面による許可なく無断で使用、改変、複製または公開する行為を禁止する。 日本語と英語の表現上疑義又は紛議が生じた時は、日本語が優先する。 COPYRIGHT © 2024 J.S.T. MFG.CO., LTD.

			0		
(年月	8	8		l
TIONS	DAT			0	
1-45-7/.1 10.1		_			
<u>補強板:ポリ</u> Reinfor	cing 1	plate	e:		
Polyim		75µm			
<u>熱硬化接着剤(</u> Thermos	etting			_	
adhesi ∾ ⊐• ≠41					
<u>ベース: ポリ</u> Base: P	olyim	ide ;	25µm	_	
熱硬化接着剤	25µm			_	
Thermos adhesi	etting			_	
道休: 王延銅		<i>,</i> ,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,			
Conduct rolled		or 31	5.um	_	
	сорр				
<u>熱硬化接着剤</u> Thermos		9		_	
adhesi [.]					
<u>カバーレイ: ;</u> Cover l	<u>ホリイミド</u> ay: P	olyi	mide	-	C
					\
<u>処</u> 理 SURFACE FIN	NISH		備考 REMARKS		
- 納入先 CUSTOMER				殿	
- 品名 SERIES NAME	<u>FHAネクタ用O</u> Applicabl	.5mmピッチ e FPC f	適合FPC(金め or O.5mm old plate	pich	
形番	FHA conne	ctor (G	old plate	d)	
PART No.	KRD-318	874-4	RO		
DRAWING No.			EC412		l

²⁰²⁴⁰⁵¹⁷J397456